



## TE0722 Test Board

Revision v.8

Exported on 2023-02-03

Online version of this document:

<https://wiki.trenz-electronic.de/display/PD/TE0722+Test+Board>

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## 4 Overview

Zynq PS Design with DDR Less FSBL Example.

Refer to <http://trenz.org/te0722-info> for the current online version of this manual and other available documentation.

### 4.1 Key Features

- Vivado 2019.2
- UART
- I2C
- FMeter
- Modified FSBL for DDR Less Zynq
- Modified FSBL for DDR Less Zynq + small app with LED+Sensor access
- Special FSBL for QSPI programming

### 4.2 Revision History

| Date       | Vivado | Project Built   | Authors       | Description   |
|------------|--------|---|---------------|---|
| 2020-04-16 | 2019.2 | TE0722-test_board_noprebuilt-vivado_2019.2-build_10_20200416064916.zip<br>TE0722-test_board-vivado_2019.2-build_10_20200416064756.zip | John Hartfiel | <ul style="list-style-type: none"> <li>• 2019.2 update</li> </ul>   |
| 2019-05-22 | 2018.3 | TE0722-test_board-vivado_2018.3-build_05_20190522113216.zip<br>TE0722-test_board_noprebuilt-vivado_2018.3-build_05_20190522113228.zip | John Hartfiel | <ul style="list-style-type: none"> <li>• split FSBL into 2 templates, one with and one without Sensor+LED access example app</li> </ul>   |
| 2019-05-14 | 2018.3 | TE0722-test_board-vivado_2018.3-build_05_20190510163659.zip<br>TE0722-test_board_noprebuilt-vivado_2018.3-build_05_20190510163900.zip | John Hartfiel | <ul style="list-style-type: none"> <li>• TE Script update</li> <li>• rework of the FSBLs               <ul style="list-style-type: none"> <li>• DDR LESS, Device ID, Sensor+LED access</li> </ul> </li> <li>• VIO for RGB access</li> </ul> |

| Date       | Vivado | Project Built   | Authors        | Description   |
|------------|--------|---|----------------|---|
| 2018-08-14 | 2018.2 | TE0722-test_board-vivado_2018.2-build_02_20180815123557.zip<br>TE0722-test_board_noprebuilt-vivado_2018.2-build_02_20180815123610.zip | John Hartfield | <ul style="list-style-type: none"> <li>initial release</li> </ul> |

**Table 1: Design Revision History**

## 4.3 Release Notes and Known Issues

| Issues                             | Description   | Workaround  | To be fixed version |
|------------------------------------|---|---|---------------------|
| Flash Programming failed with 19.2 | Depending on Flash content Flash programming failed with provided fsbl_flash (Xilinx <a href="https://www.xilinx.com/support/answers/70548.html">AR#70548</a> <sup>1</sup> ) 2019.2 version | <ul style="list-style-type: none"> <li>Option1: <ul style="list-style-type: none"> <li>In case Flash is empty, use fsbl_flash on programming GUI</li> <li>In case Flash is programmed use normal fsbl on programming GUI</li> </ul> </li> <li>Option2: use in both case fsbl_flash on programming GUI and Vivado LabTools 2018.3</li> </ul> |                     |

**Table 2: Known Issues**

## 4.4 Requirements

### 4.4.1 Software

| Software | Version | Note   |
|----------|---------|--|
| Vitis    | 2019.2  | needed, Vivado is included into Vitis installation |

**Table 3: Software**

<sup>1</sup> <https://www.xilinx.com/support/answers/70548.html>

## 4.4.2 Hardware

Basic description of TE Board Part Files is available on [TE Board Part Files](#).<sup>2</sup>

Complete List is available on <design name>/board\_files/\*\_board\_files.csv

Design supports following modules:

| Module Model     | Board Part Short Name | PCB Revision Support | DDR | QSPI Flash | EMMC | Others       | Notes |
|------------------|-----------------------|----------------------|-----|------------|------|--------------|-------|
| TE0722-01        | 10                    | REV01                | 0GB | 16MB       | NA   | NA           | NA    |
| TE0722-02        | 10                    | REV02                | 0GB | 16MB       | NA   | NA           | NA    |
| TE0722-02I       | 10_i                  | REV02                | 0GB | 16MB       | NA   | NA           | NA    |
| TE0722-02I C7    | 10_i_c7               | REV02                | 0GB | 16MB       | NA   | "without SD" | NA    |
| TE0722-02-07S-1C | 7s                    | REV02                | 0GB | 16MB       | NA   | NA           | NA    |

**Table 4: Hardware Modules**

Design supports following carriers:

| Carrier Model | Notes |
|---------------|-------|
| ---           |       |

**Table 5: Hardware Carrier**

Additional HW Requirements:

| Additional Hardware        | Notes          |
|----------------------------|----------------|
| TE0790                     | for JTAG, UART |
| external 3.3V power supply |                |

**Table 6: Additional Hardware**

<sup>2</sup> <https://wiki.trenz-electronic.de/display/PD/TE+Board+Part+Files>



## 4.5 Content

For general structure and of the reference design, see [Project Delivery - Xilinx devices](https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+Xilinx+devices)<sup>3</sup>

### 4.5.1 Design Sources

| Type   | Location  | Notes   |
|--------|---|---|
| Vivado | <design name>/<br>block_design<br><design name>/<br>constraints<br><design name>/ip_lib | Vivado Project will be generated by TE Scripts  |
| Vitis  | <design name>/sw_lib  | Additional Software Template for Vitis and apps_list.csv with settings automatically for Vitis app generation |

**Table 7: Design sources**

### 4.5.2 Additional Sources

| Type | Location | Notes |
|------|----------|-------|
| --   | --       | --    |

**Table 8: Additional design sources**

### 4.5.3 Prebuilt

| File     | File-Extension | Description   |
|----------|----------------|---|
| BIF-File | *.bif          | File with description to generate Bin-File            |
| BIN-File | *.bin          | Flash Configuration File with Boot-Image (Zynq-FPGAs) |
| BIT-File | *.bit          | FPGA (PL Part) Configuration File                     |

<sup>3</sup> <https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+Xilinx+devices>

| File                                  | File-Extension | Description  |
|---------------------------------------|----------------|--|
| DebugProbes-File                      | *.ltx          | Definition File for Vivado/Vivado Labtools Debugging Interface |
| Diverse Reports                       | ---            | Report files in different formats                              |
| Hardware-Platform-Specification-Files | *.xsa          | Exported Vivado Hardware Specification for Vitis and PetaLinux |
| LabTools Project-File                 | *.lpr          | Vivado Labtools Project File                                   |
| Software-Application-File             | *.elf          | Software Application for Zynq or MicroBlaze Processor Systems  |

**Table 9: Prebuilt files (only on ZIP with prebuilt content)**

#### 4.5.4 Download

Reference Design is only usable with the specified Vivado/SDK/PetaLinux/SDx version. Do never use different Versions of Xilinx Software for the same Project.

Reference Design is available on:

- [TE0722 "Test Board" Reference Design](https://shop.trenz-electronic.de/Download/?path=Trenz_Electronic/Modules_and_Module_Carriers/special/TE0722/Reference_Design/2019.2/test_board)<sup>4</sup>

<sup>4</sup> [https://shop.trenz-electronic.de/Download/?path=Trenz\\_Electronic/Modules\\_and\\_Module\\_Carriers/special/TE0722/Reference\\_Design/2019.2/test\\_board](https://shop.trenz-electronic.de/Download/?path=Trenz_Electronic/Modules_and_Module_Carriers/special/TE0722/Reference_Design/2019.2/test_board)

## 5 Design Flow

**!** Reference Design is available with and without prebuilt files. It's recommended to use TE prebuilt files for first lunch.

Trenz Electronic provides a tcl based built environment based on Xilinx Design Flow.

See also:

- [Xilinx Development Tools](#)<sup>5</sup>
- [Vivado Projects - TE Reference Design](#)<sup>6</sup>
- [Project Delivery](#).<sup>7</sup>

The Trenz Electronic FPGA Reference Designs are TCL-script based project. Command files for execution will be generated with "\_create\_win\_setup.cmd" on Windows OS and "\_create\_linux\_setup.sh" on Linux OS.

TE Scripts are only needed to generate the vivado project, all other additional steps are optional and can also be executed by Xilinx Vivado/SDK GUI. For currently Scripts limitations on Win and Linux OS see: [Project Delivery Currently limitations of functionality](#)<sup>8</sup>

1. \_create\_win\_setup.cmd/\_create\_linux\_setup.sh and follow instructions on shell:

```

C:\WINDOWS\system32\cmd.exe
B:\Design\cores\xilinx\2018.3\design\TE0722\test_board>setlocal
-----Set design paths-----
-- Run Design with: _create_win_setup
-- Use Design Path: B:\Design\cores\xilinx\2018.3\design\TE0722\test_board\
-----TE Reference Design-----
-- (c) Go to CMD-File Generation (Manual setup)
-- (d) Go to Documentation (Web Documentation)
-- (x) Exit Batch (nothing is done!)
-- (0) Module selection guide, project creation...
-- (1) Create minimum setup of CMD-Files and exit Batch
-- (2) Create maximum setup of CMD-Files and exit Batch
-----
Select (ex.: '0' for module selection guide):
  
```

2. Press 0 and enter to start "Module Selection Guide"
3. (optional Win OS) Generate Virtual Drive or use short directory for the reference design (for example x: \<design name>)
4. Create Project (follow instruction of the product selection guide), settings file will be configured automatically during this process
  - a. (optional for manual changes) Select correct device and Xilinx install path on "design\_basic\_settings.cmd" and create Vivado project with "vivado\_create\_project\_gui mode.cmd"

Note: Select correct one, see [TE Board Part Files](#)<sup>9</sup>
5. Create XSA and export to prebuilt folder
  - a. Run on Vivado TCL: TE::hw\_build\_design -export\_prebuilt

Note: Script generate design and export files into \prebuilt\hardware\<short dir>. Use GUI is the same, except file export to prebuilt folder
6. Generate Programming Files with Vitis

<sup>5</sup> <https://wiki.trenz-electronic.de/display/PD/Xilinx+Development+Tools#XilinxDevelopmentTools-XilinxSoftware-BasicUserGuides>


<sup>6</sup> <https://wiki.trenz-electronic.de/display/PD/Vivado+Projects+-+TE+Reference+Design>

<sup>7</sup> <https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+Xilinx+devices>

<sup>8</sup> <https://wiki.trenz-electronic.de/display/PD/Project+Delivery+-+Xilinx+devices#ProjectDeliveryXilinxdevices-Currentlylimitationsoffunctionality>

<sup>9</sup> <https://wiki.trenz-electronic.de/display/PD/TE+Board+Part+Files>

- a. Run on Vivado TCL: `TE::sw_run_vitis -all`  
Note: Scripts generate applications and bootable files, which are defined in "sw\_lib\apps\_list.csv"
- b. (alternative) Start SDK with Vivado GUI or start with TE Scripts on Vivado TCL: `TE::sw_run_vitis`  
Note: TCL scripts generate also platform project, this must be done manually in case GUI is used. See [Vitis](#)<sup>10</sup>  
Projects contains 3 FSBL template: `zynq_fsbl` (FSBL modified for DDR Less application → use for Boot.bin), `zynq_fsbl_app` (FSBL modified for DDR Less application and with demo app included → create Boot with this FSBL and Bitstream only), `zynq_fsbl_flash` (FSBL modified for Flash programming → FSBL which must be selected separately to program Flash)

 TE0722 is without DDR, so special FSBL (sources on reference designs) is needed, see also: [DDR less ZYNQ Design](#)<sup>11</sup>

---

<sup>10</sup> <https://wiki.trenz-electronic.de/display/PD/Vitis>

<sup>11</sup> <https://wiki.trenz-electronic.de/display/PD/DDR+less+ZYNQ+Design>


## 6 Launch

---

Basic Information, see [TE0722 Getting Started](#)<sup>12</sup>

### 6.1 Programming

---

 Check Module and Carrier TRMs for proper HW configuration before you try any design.

Xilinx documentation for programming and debugging: [Vivado/SDK/SDSoC-Xilinx Software Programming and Debugging](#)<sup>13</sup>

#### 6.1.1 Get prebuilt boot binaries

---

1. `_create_win_setup.cmd/_create_linux_setup.sh` and follow instructions on shell
2. Press 0 and enter to start "Module Selection Guide"
  - a. Select assembly version
  - b. Validate selection
  - c. Select Create and open delivery binary folder  
Note: Folder (`<project folder>/_binaries_<Artikel Name>`) with subfolder (`boot_<app name>`) for different applications will be generated

#### 6.1.2 QSPI

---

Optional for Boot.bin on QSPI Flash

1. Connect JTAG and power on carrier with module
2. Open Vivado Project with "`vivado_open_existing_project_gui mode.cmd`" or if not created, create with "`vivado_create_project_gui mode.cmd`"
3. Type on Vivado TCL Console: `TE::pr_program_flash -swapp u-boot`  
Note: To program with SDK/Vivado GUI, use special FSBL (`zynqmp_fsbl_flash`) on setup optional "`TE::pr_program_flash -swapp zynq_fsbl_app`" possible

#### 6.1.3 SD

---

Xilinx Zynq devices in CLG225 package do not support SD Card boot directly from ROM bootloader. Use QSPI for primary boot and SD for secondary boot only. See also [Xilinx AR#66846](#)<sup>14</sup>

#### 6.1.4 JTAG

---

Not used on this Example.

## 6.2 Usage

---

1. Prepare HW like described on section [Programming](#)(see page 13)

---

<sup>12</sup> <https://wiki.trenz-electronic.de/display/PD/TE0722+Getting+Started>

<sup>13</sup> <https://wiki.trenz-electronic.de/display/PD/Xilinx+Development+Tools#XilinxDevelopmentTools-XilinxSoftwareProgrammingandDebugging>

<sup>14</sup> <https://www.xilinx.com/support/answers/66846.html>

2. Connect UART USB (most cases same as JTAG)
3. Power On PCB

Note: 1. Zynq Boot ROM loads FSBL from QSPI into OCM, 2. FSBL loads bitfile from QSPI, 3. FSBL starts application (included into the FSBL Code)

### 6.2.1 Baremetal App

Note: UART over J2 is used, this is only available, if PL part is configured with correct UART connection.

1. Open Serial Console (e.g. putty)
  - a. Speed: 115200
  - b. COM Port: Win OS, see device manager, Linux OS see `dmesg |grep tty` (UART is \*USB1)
2. Output:
  - a. Default output appears only 10 time. Reboot device: force ResN Pin to GND for short time, location see: [TE0722 Getting Started](#)<sup>15</sup>

```
Device IDCODE: 13723093
Device Name: 7z007s (3)
Device Revision: 1
-----
TE0722 TE_FsblHookBeforeHandoff_Custom

  Read LIGHT SENSOR ID: Si1143 Revision: 0 Sequencer Revision: A11
LED D4 off (Remaining Loops 0xA)

  Read LIGHT SENSOR ID: Si1143 Revision: 0 Sequencer Revision: A11
LED D4 off (Remaining Loops 0x9)

  Read LIGHT SENSOR ID: Si1143 Revision: 0 Sequencer Revision: A11
LED D4 off (Remaining Loops 0x8)

  Read LIGHT SENSOR ID: Si1143 Revision: 0 Sequencer Revision: A11
LED D4 off (Remaining Loops 0x7)

  Read LIGHT SENSOR ID: Si1143 Revision: 0 Sequencer Revision: A11
LED D4 off (Remaining Loops 0x6)

  Read LIGHT SENSOR ID: Si1143 Revision: 0 Sequencer Revision: A11
LED D4 off (Remaining Loops 0x5)

  Read LIGHT SENSOR ID: Si1143 Revision: 0 Sequencer Revision: A11
LED D4 off (Remaining Loops 0x4)

  Read LIGHT SENSOR ID: Si1143 Revision: 0 Sequencer Revision: A11
LED D4 off (Remaining Loops 0x3)

  Read LIGHT SENSOR ID: Si1143 Revision: 0 Sequencer Revision: A11
LED D4 on (Remaining Loops 0x2)
```

### 6.2.2 Vivado HW Manager

Open Vivado HW-Manager and add VIO signal to dashboard (\*.ltx located on prebuilt folder)

- Control:
  - Enable/Disable RGB LED Counter (default on)
  - Enable/Disable different colors (default all off)

<sup>15</sup> <https://wiki.trenz-electronic.de/display/PD/TE0722+Getting+Started>

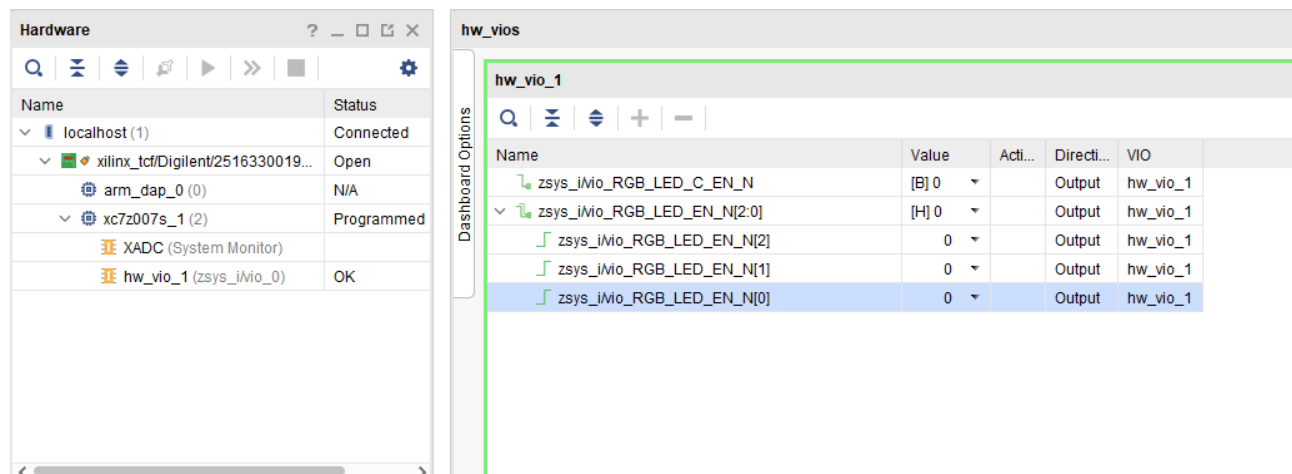
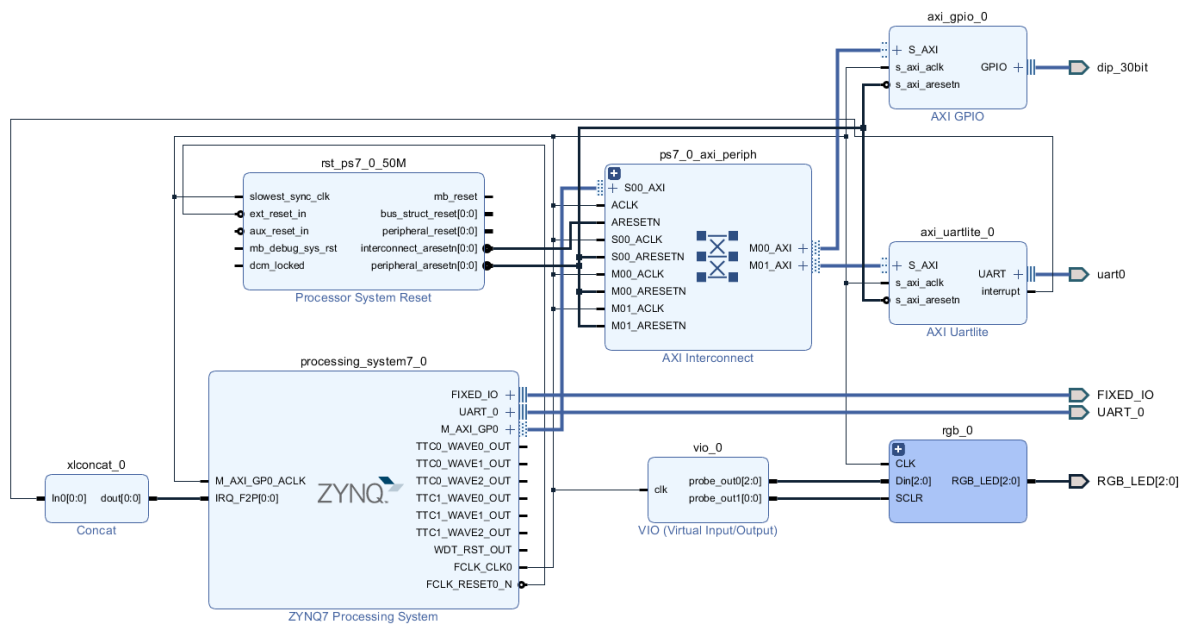


Figure 1: Vivado Hardware Manager

## 7 System Design - Vivado

### 7.1 Block Design



**Figure 2: Block Design**

#### 7.1.1 PS Interfaces

| Type  | Note      |
|-------|-----------|
| DDR   | Disabled! |
| QSPI  | MIO       |
| SD    | MIO       |
| UART0 | EMIO      |
| I2C1  | MIO       |
| GPIO  | MIO       |
| SWDT0 | EMIO      |



| Type    | Note |
|---------|------|
| TTC0..1 | EMIO |

**Table 10: PS Interfaces**

## 7.2 Constrains

### 7.2.1 Basic module constrains

#### **\_i\_bitgen\_common.xdc**

```
#
# Common BITGEN related settings for TE0722
#
set_property BITSTREAM.GENERAL.COMPRESS TRUE [current_design]
set_property CONFIG_VOLTAGE 3.3 [current_design]
set_property CFGBVS VCC0 [current_design]

set_property BITSTREAM.CONFIG.UNUSEDPIN PULLUP [current_design]
```

### 7.2.2 Design specific constrain

#### **\_i\_uart\_j2xmod.xdc**

```
set_property PACKAGE_PIN K15 [get_ports UART_0_txd]
set_property PACKAGE_PIN L13 [get_ports UART_0_rxd]

set_property IOSTANDARD LVCMOS33 [get_ports UART_0_*]
```

#### **\_i\_io.xdc**

```
#RGB LED
#R
set_property PACKAGE_PIN J15 [get_ports {RGB_LED[0]}]
#G
set_property PACKAGE_PIN L14 [get_ports {RGB_LED[1]}]
#B
set_property PACKAGE_PIN K12 [get_ports {RGB_LED[2]}]
set_property IOSTANDARD LVCMOS33 [get_ports {RGB_LED[*]}]
```

## 8 Software Design - Vitis

---

For SDK project creation, follow instructions from:

Vitis<sup>16</sup>

### 8.1 Application

---

Source location: \sw\_lib\sw\_apps

#### 8.1.1 zynq\_fsbl

---

TE modified 2019.2 FSBL

General:

- Modified Files: main.c, fsbl\_hooks.h/.c (search for 'TE Mod' on source code)
- Add Files: te\_fsbl\_hooks.h/.c (for hooks and board)\n\
- General Changes:
  - Display FSBL Banner and Device ID
  - **Disable Memory initialisation on main.c**

#### 8.1.2 zynq\_fsbl\_app

---

TE modified 2019.2 FSBL

General:

- Modified Files: main.c, fsbl\_hooks.h/.c (search for 'TE Mod' on source code)
- Add Files: te\_fsbl\_hooks.h/.c (for hooks and board)\n\
- General Changes:
  - Display FSBL Banner and Device ID
  - **Disable Memory initialisation on main.c**

Module Specific:

- Add Files: all TE Files start with te\_\*
  - Example app for LED access over MIO and sensor access over I2C

#### 8.1.3 zynq\_fsbl\_flash

---

TE modified 2019.2 FSBL

General:

- Modified Files: main.c
- General Changes:
  - Display FSBL Banner
  - Set FSBL Boot Mode to JTAG
  - Disable Memory initialisation

---

<sup>16</sup> <https://wiki.trenz-electronic.de/display/PD/Vitis>

## 9 Appx. A: Change History and Legal Notices

### 9.1 Document Change History

To get content of older revision go to "Change History" of this page and select older document revision number.

| Date   | Document Revision | Authors                                     | Description  |
|--|-------------------|---|--|
|  2020-04-16 | v.8(see page 6)   | <a href="#">John Hartfiel</a> <sup>17</sup> | <ul style="list-style-type: none"> <li>• 2019.2 release</li> </ul>                               |
| 2020-04-16   | v.7               | John Hartfiel                               | <ul style="list-style-type: none"> <li>• separate template for FSBL with App included</li> </ul> |
| 2019-05-14   | v.6               | John Hartfiel                               | <ul style="list-style-type: none"> <li>• 2018.3 release</li> </ul>                               |
| 2018-08-15   | v.5               | John Hartfiel                               | <ul style="list-style-type: none"> <li>• 2018.2 release</li> </ul>                               |
| --   | all               | <a href="#">John Hartfiel</a> <sup>18</sup> | --   |

**Table 11: Document change history.**

### 9.2 Legal Notices

### 9.3 Data Privacy

Please also note our data protection declaration at <https://www.trenz-electronic.de/en/Data-protection-Privacy>

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<sup>17</sup> <https://wiki.trenz-electronic.de/display/~j.hartfiel>

<sup>18</sup> <https://wiki.trenz-electronic.de/display/~j.hartfiel>

## 9.5 Limitation of Liability

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To confront directly with the responsibility toward the environment, the global community and eventually also oneself. Such a resolution should be integral part not only of everybody's life. Also enterprises shall be conscious of their social responsibility and contribute to the preservation of our common living space. That is why Trenz Electronic invests in the protection of our Environment.

## 9.9 REACH, RoHS and WEEE

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### **REACH**

Trenz Electronic is a manufacturer and a distributor of electronic products. It is therefore a so called downstream user in the sense of [REACH](http://guidance.echa.europa.eu/)<sup>19</sup>. The products we supply to you are solely non-chemical products (goods). Moreover and under normal and reasonably foreseeable circumstances of application, the goods supplied to you shall not release any substance. For that, Trenz Electronic is obliged to neither register nor to provide safety data sheet. According to present knowledge and to best of our knowledge, no [SVHC \(Substances of Very High Concern\) on the Candidate List](https://echa.europa.eu/candidate-list-table)<sup>20</sup> are contained in our products. Furthermore, we will immediately and unsolicited inform our customers in compliance with REACH - Article 33 if any substance present in our goods (above a concentration of 0,1 % weight by weight) will be classified as SVHC by the [European Chemicals Agency \(ECHA\)](http://www.echa.europa.eu/)<sup>21</sup>.

### **RoHS**

Trenz Electronic GmbH herewith declares that all its products are developed, manufactured and distributed RoHS compliant.

### **WEEE**

Information for users within the European Union in accordance with Directive 2002/96/EC of the European Parliament and of the Council of 27 January 2003 on waste electrical and electronic equipment (WEEE).

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<sup>19</sup> <http://guidance.echa.europa.eu/>

<sup>20</sup> <https://echa.europa.eu/candidate-list-table>

<sup>21</sup> <http://www.echa.europa.eu/>

Users of electrical and electronic equipment in private households are required not to dispose of waste electrical and electronic equipment as unsorted municipal waste and to collect such waste electrical and electronic equipment separately. By the 13 August 2005, Member States shall have ensured that systems are set up allowing final holders and distributors to return waste electrical and electronic equipment at least free of charge. Member States shall ensure the availability and accessibility of the necessary collection facilities. Separate collection is the precondition to ensure specific treatment and recycling of waste electrical and electronic equipment and is necessary to achieve the chosen level of protection of human health and the environment in the European Union. Consumers have to actively contribute to the success of such collection and the return of waste electrical and electronic equipment. Presence of hazardous substances in electrical and electronic equipment results in potential effects on the environment and human health. The symbol consisting of the crossed-out wheeled bin indicates separate collection for waste electrical and electronic equipment.

Trenz Electronic is registered under WEEE-Reg.-Nr. DE97922676.

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